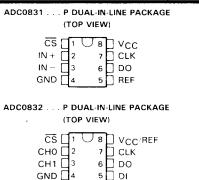
D2795, AUGUST 1985-- REVISED JUNE 1986

- 8-Bit Resolution
- Easy Microprocessor Interface or Stand-Alone Operation
- Operates Ratiometrically or with 5-V Reference
- Single Channel or Multiplexed Twin Channels with Single-Ended or Differential Input Options
- Input Range 0 to 5 V with Single 5-V Supply
- Inputs and Outputs are Compatible with TTL and MOS
- Conversion Time of 32 μs at CLK = 250 kHz
- Designed to be Interchangeable with National Semiconductor ADC0831 and ADC0832

DEVICE	TOTAL UNADJUSTED ERROR					
DEVICE	A-SUFFIX	B-SUFFIX				
ADC0831	±1 LSB	± ½ LSB				
ADC0832	+1 LSB	± ½ LSB				



description

These devices are 8-bit successive-approximation analog-to-digital converters. The ADC0831A and ADC0831B have single input channels; the ADC0832A and ADC0832B have multiplexed twin input channels. The serial output is configured to interface with standard shift registers or microprocessors. Detailed information on interfacing to most popular microprocessors is readily available from the factory.

The ADC0832 multiplexer is software configured for single-ended or differential inputs. The differential analog voltage input allows for common-mode rejection or offset of the analog zero input voltage value. In addition, the voltage reference input can be adjusted to allow encoding any smaller analog voltage span to the full 8 bits of resolution.

The operation of the ADC0831 and ADC0832 devices is very similar to the more complex ADC0834 and ADC0838 devices. Ratiometric conversion can be attained by setting the REF input equal to the maximum analog input signal value, which gives the highest possible conversion resolution. Typically, REF is set equal to V_{CC} (done internally on the ADC0832). For more detail on the operation of the ADC0831 and ADC0832 devices, refer to the ADC0834/ADC0838 data sheet.

The ADC0831AI, ADC0831BI, ADC0832AI, and ADC0832BI are characterized for operation from $-40\,^{\circ}$ C to 85 °C. The ADC0831AC, ADC0831BC, ADC0832AC, and ADC0832BC are characterized for operation from 0 °C to 70 °C.

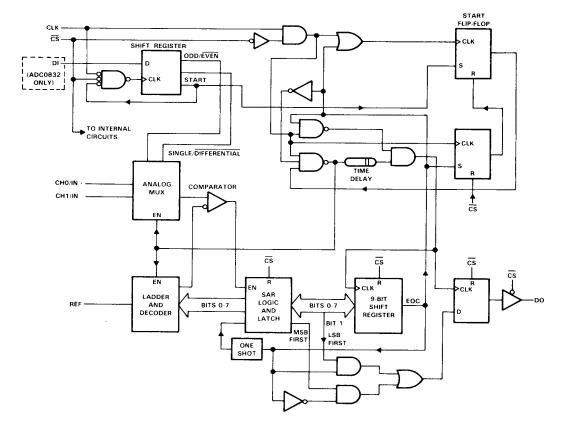
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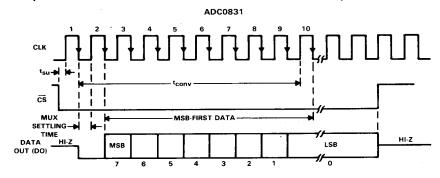
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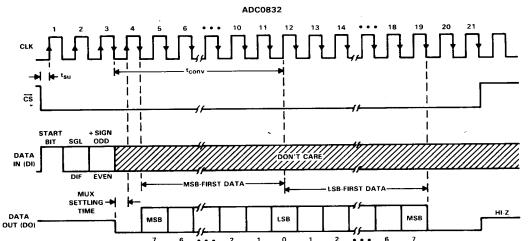
2-39

functional block diagram



sequence of operation





ADC0832 MUX ADDRESS CONTROL LOGIC TABLE

MUX	ADDRESS	CHANNEL NUMBER
SGL/DIF	ODD/EVEN	0 1
Ļ	L	+ -
L	н	- +
. н	L	+ .
н	н	+

H = high level, L = low level, - or + = polarity of selected input pin



absolute maximum ratings over recommended operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	6.5 V
Input voltage range: Logic	-0.3 V to 15 V
Analog	V to V _{CC} + 0.3 V
Input current	± 5 mA
Total input current for package	± 20 mA
Operating free-air temperature range: I-suffix	40°C to 85°C
C-suffix	0°C to 70°C
Storage temperature range	-65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

NOTE 1: All voltage values, except differential voltages, are with respect to the network ground terminal.

recommended operating conditions

			MIN	NOM	MAX	UNIT
Vcc	Supply voltage		4.5	5	6.3	V
VIH	High-level input voltage		2			
VIL	Low-level input voltage				0.8	V
fclock	Clock frequency		10		400	kHz
	Clock duty cycle (see Note 2)		40		60	%
twH(CS)	Pulse duration, CS high		220			ns
t _{su}	Setup time, CS low or ADC0832	data valid before clock1	350			ns
th	Hold time, ADC0832 data valid a	after clock1	90			ns
_	•	I-suffix	-40		85	°C
TA	Operating free-air temperature	C-suffix	0		70	ا ا

NOTE 2: The clock duty cycle range ensures proper operation at all clock frequencies. If a clock frequency is used outside the recommended duty cycle range, the minimum pulse duration (high or low) is 1 µs.

electrical characteristics over recommended range of operating free-air temperature, $V_{CC} = 5 \text{ V}$, $f_{clock} = 250 \text{ kHz}$ (unless otherwise noted)

digital section

		TEST CONDITIONS†		I SUFFIX				LIMIT		
	PARAMETER			MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
Voн	High-level output voltage	$V_{CC} = 4.75 \text{ V},$ $V_{CC} = 4.75 \text{ V},$		2.4 4.5		,	2.8 4.6			٧
VOL	Low-level output voltage	V _{CC} = 4.75 V,	I _{OL} = 1.6 mA	0.4			0.34			>
ΉΗ	High-level input current	V _{IH} = 5 V			0.005	1		0.005	1	μА
IIL	Low-level input current	V _{IL} = 0			-0.005	- 1		-0.005	- 1	μА
ЮН	High-level output (source) current	V _{OH} = V ₀ ,	T _A = 25°C	-6.5	- 14		-6.5	- 14		mA
lOL	Low-level output (sink) current	V _{OL} = V _{CC} ,	T _A = 25°C	8	16		8	16		mA
loz	High-impedance- state output	V _O = 5 V,	T _A = 25°C		0.01	3		0.01	3	μА
.02	current (DO)	V _O = 0,	T _A = 25°C		-0.01	- 3		-0.01	- 3	
Ci	Input capacitance				5			5		pF
c _o	Output capacitance				5			5		pF

[†] All parameters are measured under open-loop conditions with zero common-mode input voltage.

 $^{^{\}ddagger}$ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25 ^{\circ}\text{C}$.



electrical characteristics over recommended range of operating free-air temperature, $V_{CC} = 5 \text{ V}$, $f_{clock} = 250 \text{ kHz}$ (unless otherwise noted)

analog and converter section

	PARAMETE	R	TEST CONDITIONS†	MIN	TYP [‡]	MAX	UNIT
VICR	Common-mode in	nput voltage range	See Note 3	-0.05 to V _{CC} +0.05			V
	Standby input	On-channel V _I = 5 V at on-cha				1	
		Off-channel	V _I = 0 at off-channel			- 1	
l(stdby)	current	On-channel	V _I = 0 at on-channel,			- 1	μΑ
	(see Note 4)	Off-channel	$V_{\parallel} = 5 \text{ V at off-channel}$			1	
「i(REF)	Input resistance	to reference ladder		1.3	2.4	5.9	kΩ

total device

	P#	PARAMETER TEST CONDITIONS [†]				TYP‡	MAX	UNIT
	laa Cunnlu	aant	ADC0831			1	2.5	
ĺ	ICC Supply		ADC0832			3	5.2	mA

[†]All parameters are measured under open-loop conditions with zero common-mode input voltage.

 ‡ All typical values are at V_{CC} = 5 V, T_A = 25 °C.

- NOTES: 3. If channel IN is more positive than channel IN + , the digital output code will be 0000 0000. Connected to each analog input are two on-chip diodes that will conduct forward current for analog input voltages one diode drop above V_{CC}. Care must be taken during testing at low V_{CC} levels (4.5 V) because high-level analog input voltage (5 V) can, especially at high temperatures, cause this input diode to conduct and cause errors for analog inputs that are near full-scale. As long as the analog voltage does not exceed the supply voltage by more than 50 mV, the output code will be correct. To achieve an absolute 0 V to 5 V input voltage range requires a minimum V_{CC} of 4.95 V for all variations of temperature and load.
 - 4. Standby input currents are currents going into or out of the on or off channels when the A/D converter is not performing conversion and the clock is in a high or low steady-state condition.

operating characteristics V_{CC} = REF = 5 V, f_{clock} = 250 kHz, t_r = t_f = 20 ns, T_A = 25 °C (unless otherwise noted)

	DADAMETED	TEST CONDITIONS 5	BI,	BC SUF	FIX	AI, AC SUFFIX			UNIT	
	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	ONIT	
	Total unadjusted error		$V_{CC} = 4.75 \text{ V to } 5.25 \text{ V}$		± 1/16	± 1/4	:	± 1-16	± 1/4	LSB
			V _{ref} = 5 V,			± 1/2			± 1	LSB
			TA = MIN to MAX			1/2				LOD
	Common-mode error		Differential mode	L	± 1/16	± 1/4		± 1 16	± 1 4	LSB
	Propagation delay time, output data after CLK1 (see Note 6)	MSB-first data	C ₁ = 100 pF	650	650	1500		650	1500	ns
^t pd		LSB-first data	С[= 100 рг		250	600		250	600	113
	Output disable time,		$C_L = 10 \text{ pF},$ $R_L = 10 \text{ k}\Omega$		125	250		125	250	ns
^t dis	DO after CS1		$C_L = 100 \text{ pF},$ $R_L = 2 \text{ k}\Omega$			500			500	115
t _{conv}	Conversion time (multiple addressing time not inclu					8			8	clock periods

[§] All parameters are measured under open-loop conditions with zero common-mode input voltage. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTES: 5. Total unadjusted error includes offset, full-scale, linearity, and multiplexer errors.

The most significant-bit-first data is output directly from the comparator and therefore requires additional delay to allow for comparator response time. Least-significant-bit-first data applies only to ADC0832.



PARAMETER MEASUREMENT INFORMATION -vcc CLK GND vcc GND v_{cc} cs - Vон DATA OUT - th – th (DO) VOL ٧cc DATA IN FIGURE 2. DATA OUTPUT TIMING (DI) FIGURE 1. ADC0832 DATA INPUT TIMING ٧cc TEST POINT FROM OUTPUT UNDER **TEST** S2 (See Note A) LOAD CIRCUIT v_{CC} ζĒ cs GND GND v_{OH} -vcc DO AND \$1 open DO AND S1 closed SARS OUTPUT S2 closed SARS OUTPUT S2 open 10%

NOTE A: C_L includes probe and jig capacitance.

VOLTAGE WAVEFORMS

FIGURE 3. OUTPUT DISABLE TIME TEST CIRCUIT AND VOLTAGE WAVEFORMS

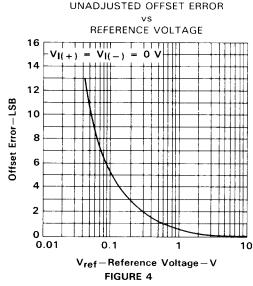
GND

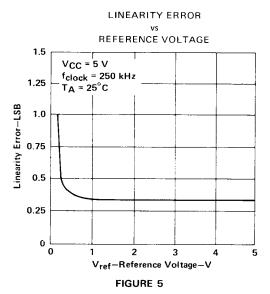
VOLTAGE WAVEFORMS

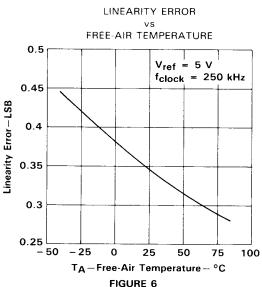
- GND

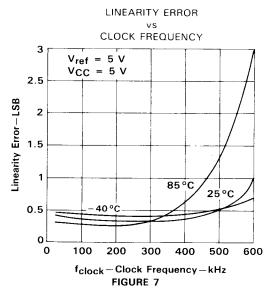


TYPICAL CHARACTERISTICS



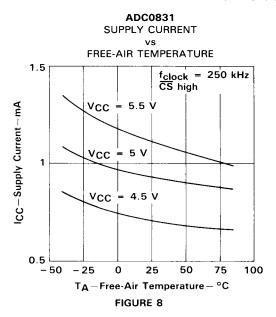


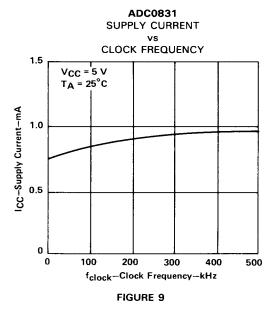






TYPICAL CHARACTERISTICS





OUTPUT CURRENT FREE-AIR TEMPERATURE 25 VCC = 5 V20 IO-Output Current-mA IOL(VOL = 5 V)15 -IOH(VOH = 0 V)10 -IOH(VOH = 2.4 V)5 IOL(VOL = 0.4 V)-50 -25 0 25 100 TA-Free-Air Temperature-°C



FIGURE 10